

O P T E JCB67
MAIL DATE CANCELLED

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Guoqiang Xing, et al.

Docket No: TI-31729

Serial No: 09/901,416

Conf. No: 7364

Examiner: Thanh T. Nguyen

Art Unit: 2813

Filed: 07/09/2001

DUAL HARDDMASK PROCESS FOR THE FORMATION OF COPPER/LOW-K
INTERCONNECTS

AP/2813
9
Response
5.29.03
only



AMENDMENT PURSUANT TO 37 CFR 1.116

Mail Stop AF
Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

etc to etc
Tm

Dear Sir:

Responsive to the Office Action mailed March 24, 2003, in connection with the
above identified application, Applicants respectfully submit the following remarks.

MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8(a)
I hereby certify that the above correspondence is being
deposited with the U.S. Postal Service with sufficient
postage as First Class Mail in an envelope addressed to:
Commissioner for Patents, P.O. Box 1450, Alexandria, VA
22313-1450 on 5-13-03.

Ann Trent
Ann Trent

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